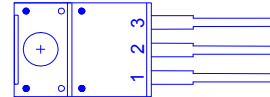
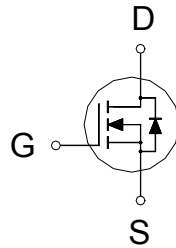


PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
200V	198mΩ	15A



1: GATE
2: DRAIN
3: SOURCE

ABSOLUTE MAXIMUM RATINGS (T_A = 25 ° C Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		V_{DS}	200	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	T _C = 25 ° C	I_D	15	A
	T _C = 100 ° C		9.3	
Pulsed Drain Current ¹		I_{DM}	45	
Avalanche Current		I_{AS}	16.5	
Avalanche Energy	L = 1mH	E_{AS}	136	mJ
Power Dissipation	T _C = 25 ° C	P_D	32	W
	T _C = 100 ° C		13	
Junction & Storage Temperature Range		T _J , T _{stg}	-55 to 150	° C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient	R _{θJA}		62.5	° C / W
Junction-to-Case	R _{θJC}		3.8	

¹Pulse width limited by maximum junction temperature.

ELECTRICAL CHARACTERISTICS (T_J = 25 ° C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	200			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.8	3	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$			±100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 200V, V_{GS} = 0V$			1	μA
		$V_{DS} = 160V, V_{GS} = 0V, T_J = 125\text{ ° C}$			10	

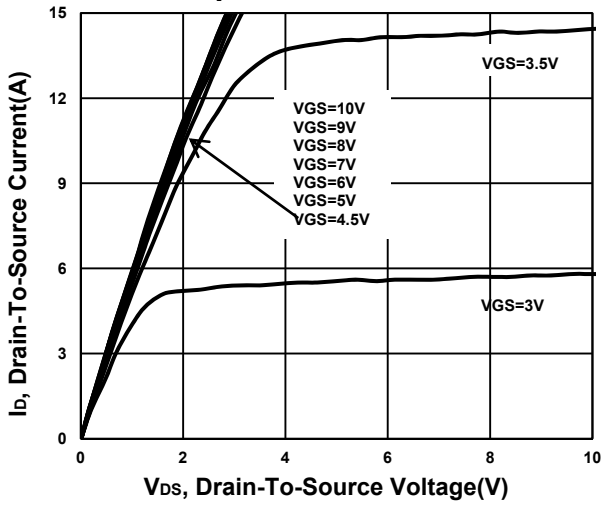
Drain-Source On-State Resistance ¹	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 7.5A$	153	198	m Ω
		$V_{GS} = 4.5V, I_D = 7.5A$	165	218	
Forward Transconductance ¹	g_{fs}	$V_{DS} = 10V, I_D = 7.5A$	14		S
DYNAMIC					
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$	869		pF
Output Capacitance	C_{oss}		150		
Reverse Transfer Capacitance	C_{rss}		22		
Total Gate Charge ²	Q_g	$V_{DS} = 160V, I_D = 15A, V_{GS} = 10V$	29		nC
Gate-Source Charge ²	Q_{gs}		2.9		
Gate-Drain Charge ²	Q_{gd}		10		
Turn-On Delay Time ²	$t_{d(on)}$	$V_{DS} = 100V, I_D \cong 15A, V_{GS} = 10V, R_{GEN} = 25\Omega$	29		nS
Rise Time ²	t_r		133		
Turn-Off Delay Time ²	$t_{d(off)}$		157		
Fall Time ²	t_f		111		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 ° C)					
Continuous Current ³	I_S			15	A
Forward Voltage ¹	V_{SD}	$I_F = 15A, V_{GS} = 0V$		1	V
Diode Reverse Recovery Time	t_{rr}	$I_F = 15A, di/dt = 100A/\mu s$	165		nS
Diode Reverse Recovery Charge	Q_{rr}		0.87		uC

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.

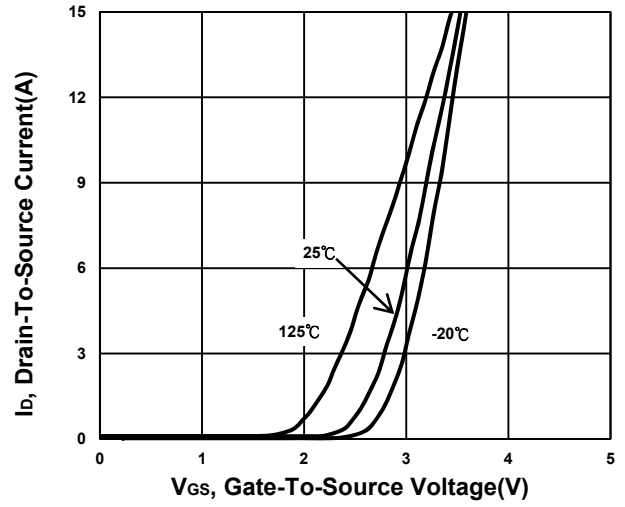
²Independent of operating temperature.

³Pulse width limited by maximum junction temperature.

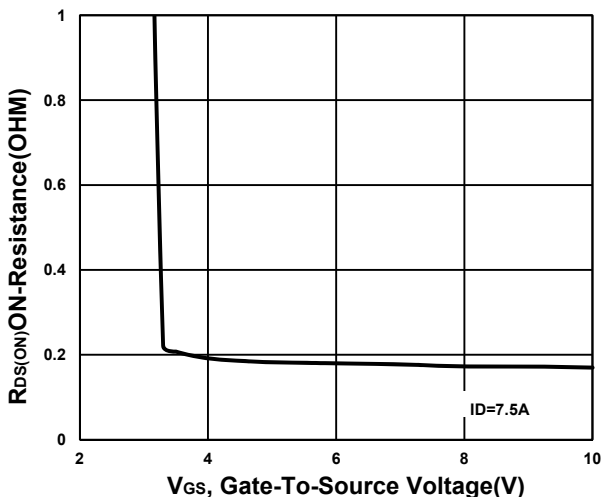
Output Characteristics



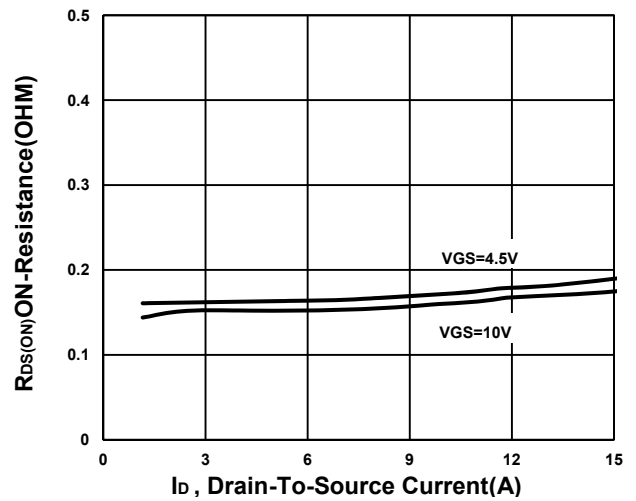
Transfer Characteristics



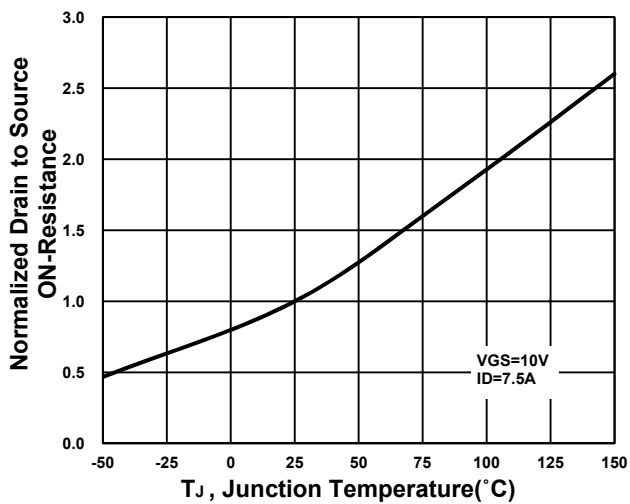
On-Resistance VS Gate-To-Source



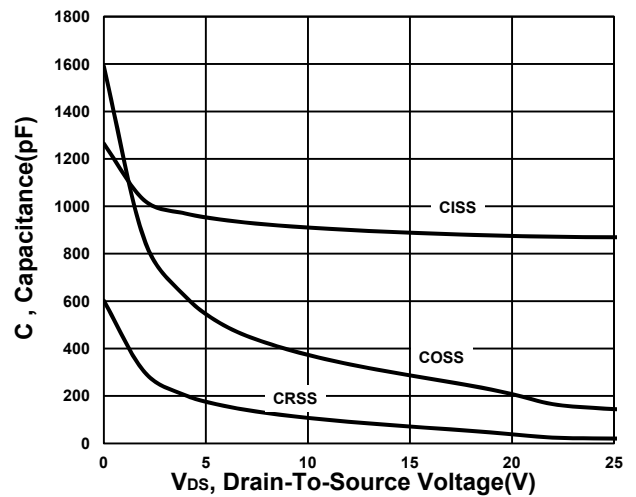
On-Resistance VS Drain Current



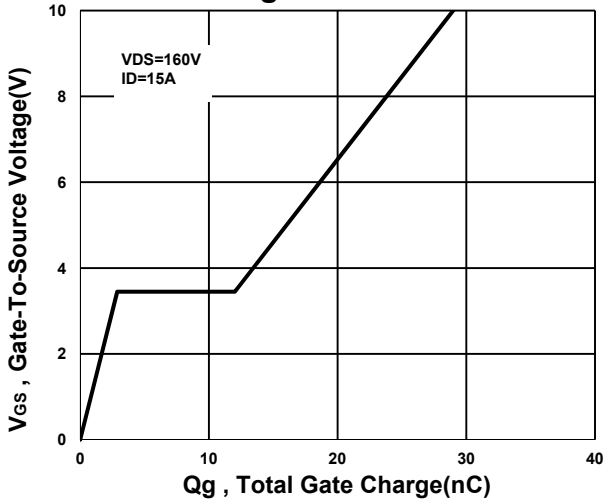
On-Resistance VS Temperature



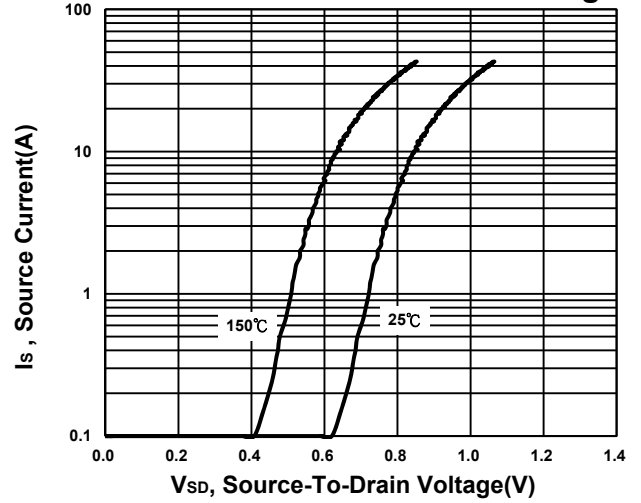
Capacitance Characteristic



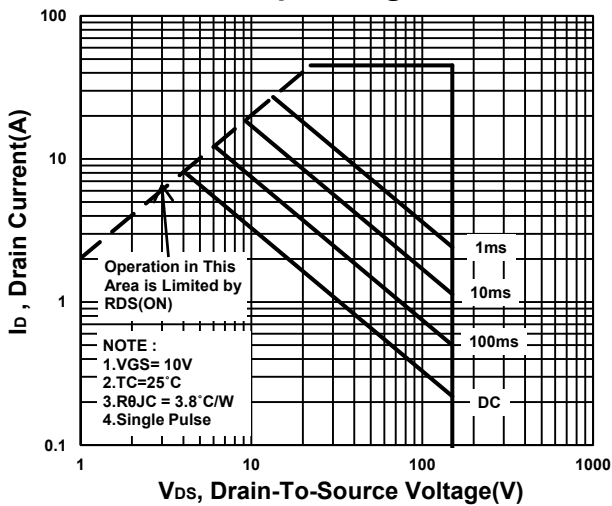
Gate charge Characteristics



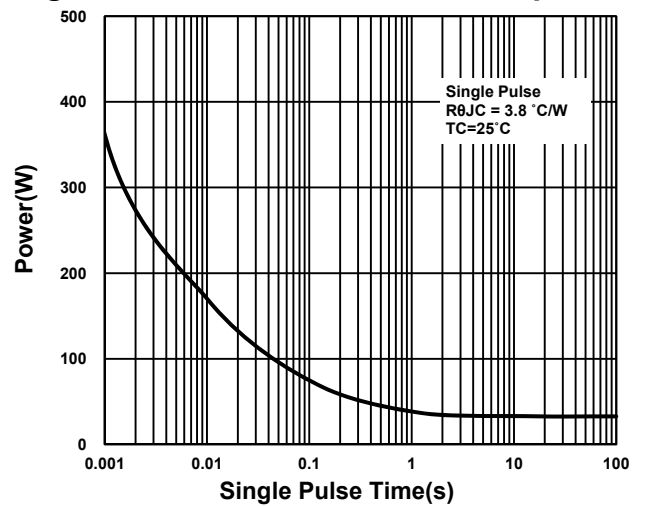
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

